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UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Mohammad Eslamy

Application No.: 09/938,075

Group Art Unit: 2815

Filed: August 23, 2001

Examiner: Joseph H. Nguyen

For:

SYMMETRIC STACK UP

Attorney Docket No.: 9818-055-999

STRUCTURE FOR ORGANIC BGA CHIP

CARRIERS

RESPONSE TO THE FIRST OFFICE ACTION

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

In response to the Office Action dated March, 15, 2002, entry of the following amendments and remarks is respectfully requested.

AMENDMENT

IN THE CLAIMS:

Please cancel claims 1-8 without prejudice.

A marked up version of the revised claims, showing insertions and deletions, is included in the Appendix attached hereto.

Please rewrite the pending claims as follows:

a. Most

9. (Amended) A semiconductor chip carrier comprising: a primary substrate;

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